



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20201030000.0

**Pin 1 Indicator marking change for select WCSP package devices
Information Only**

Date: January 15, 2021
To: Newark/Farnell PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this PCN are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services



20201030000.0
Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
BQ24163YFFT	null
BQ27421YZFT-G1B	null
TPS659127YFFR	null
BQ25898DYFFT	null
BQ27530YZFT-G1	null
BQ27621YZFT-G1A	null
BQ51020YFPT	null
BQ51021YFPT	null
BQ51025YFPT	null
TPD1S514-1YZR	null
TPS61046YFFT	null
TPS61099YFFT	null
TPS61240YFFR	null
TPS62180YZFT	null
TPS62182YZFT	null
TPS62743YFPT	null
TPS62746YFPT	null
TPS62748YFPT	null
TPS62770YFPT	null
BQ27421YZFR-G1A	null
BQ51010BYFPT	null
BQ51052BYFPT	null
TPA2025D1YZGT	null
TPS22963CZPT	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20201030000.0	PCN Date:	Jan. 15, 2021
Title:	Pin 1 Indicator marking change for select WCSP package devices		
Customer Contact:	PCN_ww_admin_team@list.ti.com	Dept:	Quality Services
Change Type:	<input type="checkbox"/> Assembly Site <input type="checkbox"/> Assembly Process <input type="checkbox"/> Assembly Materials <input type="checkbox"/> Mechanical Specification <input checked="" type="checkbox"/> Packing/Shipping/Labeling <input type="checkbox"/> Design <input type="checkbox"/> Data Sheet <input type="checkbox"/> Part number change <input type="checkbox"/> Test Site <input type="checkbox"/> Test Process <input type="checkbox"/> Wafer Bump Site <input type="checkbox"/> Wafer Bump Material <input type="checkbox"/> Wafer Bump Process <input type="checkbox"/> Wafer Fab Site <input type="checkbox"/> Wafer Fab Materials <input type="checkbox"/> Wafer Fab Process		
PCN Details			
Description of Change:			
Informational notification to announce pin 1 indicator marking change for select WCSP package devices.			
Pin 1 Device Marking:			
	Current	Proposed	
Pin 1 Device marking			
	Filled pin 1	Non-filled pin1	
Reason for Change:			
Improve device pick-up during Tape & reel process			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
None			
Changes to product identification resulting from this PCN:			
See reference picture above.			
Product Affected:			
Pls refer to page 2			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com

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